

Simulyzer-RT DIO-1 Card



Hardware version	V1.01_a
Documentation version:	1.1
Created:	April 2015
	1.1 April 2016 Note HF sealing spring
Order no.:	1.1002

Safety instructions

To avoid damages to persons and devices the following safety instructions have to be noticed!

- Only qualified personnel are allowed to handle this device!
- Before any handling within the device the current supply has to be switched off!
- During operation the device have to be positioned, that enough air condition is supplied and no small parts can get into the ventilation slots.
- In case of any trouble the system has to be switched de-energized!
- The declared environmental conditions and max. voltage ranges have to be observed!
- To warranty the device remove all dust and dirt in periodically intervals.
- Make sure that the ventilation slots are unobstructed!

Intended use:

The Simulyzer RT DIO-1 card is engineered for measurement and analysis of sensors of a RT proofing system. The field of function of the DIO-1 card is the digital data transfer within the test system (see applications).

- The device is only permitted to use for the intended use.
Any other use results the deletion of the guarantee!

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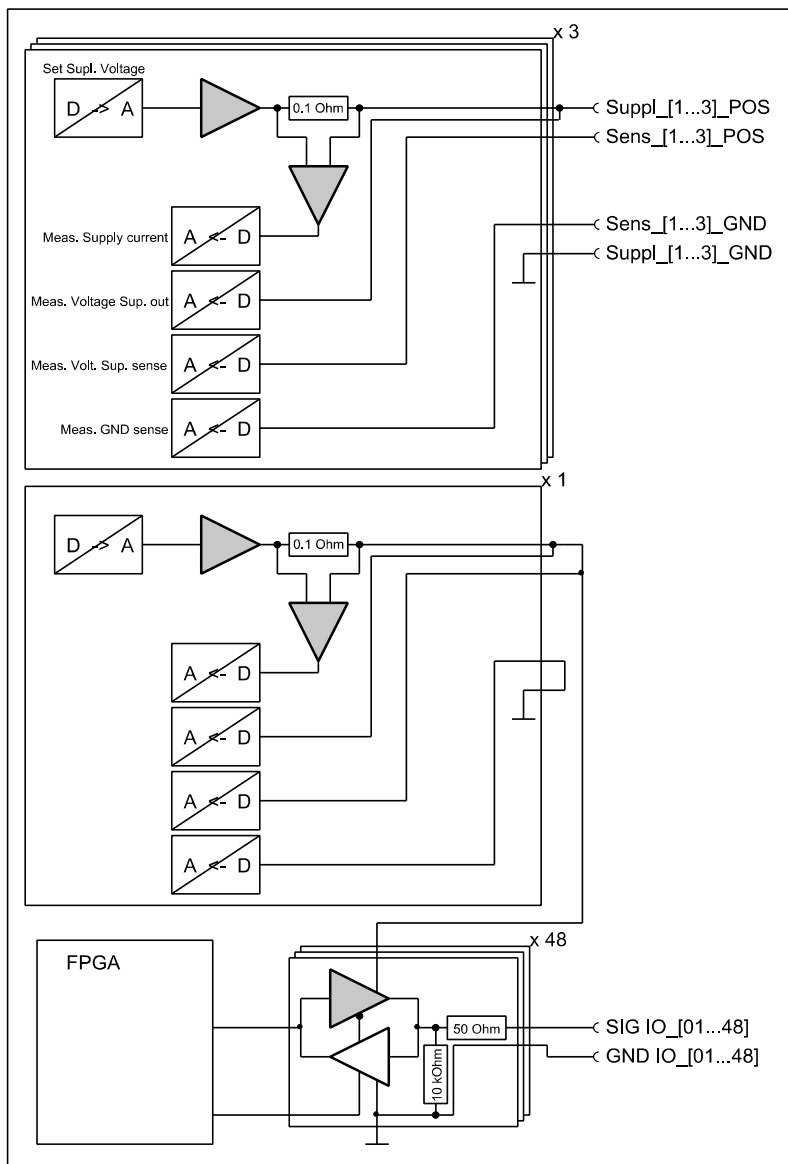
1. Technical data

- Current consumption: 12V / 0,4 A (without external consumers)
- Operating temperature: 0°C ... 40°C (32° F ... 104°F)
- Rel. Humidity: Max. 85% not condensed
- Weight: 150g
- Dimensions: Single Eurocard, 4 U

Test conditions: Environmental temperature 20°C to 26°C (68°F to 78,8°F)

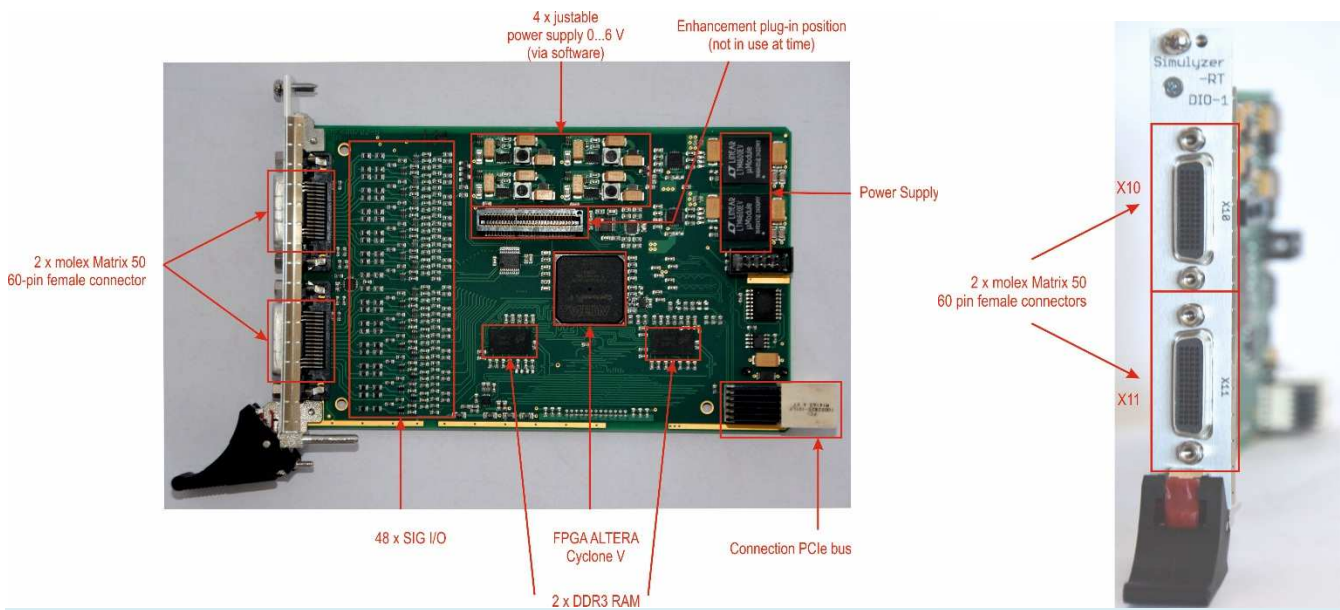
Num	Evaluation	Symbol	typ.	min.	max.	description
1	Permitted voltage range	U_{supp}	12V	11.4V	12.6V	
2	Current consumption	I_{supp}	270mA	-	400mA	Without sensor supply

2. Block diagram



3. Connectors:

- For SPI, FAST-SO
- Connectors to bus: 1 PCIe Lane to CPU-1
Power supply I2C
Parallel to all cards for synchronization
- Connectors frontside: 2x molex „Matrix 50“ 60 pin female connector with dig IO + Sensor Power

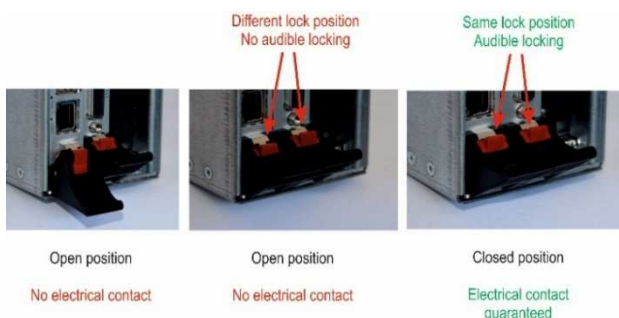


4. Interfaces and FPGA:

- ALTERA FPGA Cyclone V to realize protocolling
- 8 x SPI (MISO, MOSI, CS, CLK) + 16 Reserved DIG IO => 48 Pins
- 16xSPI (16xMISO, 16xMOSI, 8xCS, 8xCLK)/ 48 Pins
- With 16 reserved IO it is possible to realize e.g. 4 x Fast-SO
- All DIG IOs bidirectional, level adjustable from 1.2V to 5.5V operating; max. 20MHz
- 3x adjustable PU outputs,
1.5V to 6.0V, +/- 0.1% of scale final value to supply the sensors,
current limiting 0..1000mA, +/- 0.1%.
- 1x adjustable PU output, 1.5V to 6.0V, +/- 0.1% of scale final value,
current limiting 0..1000mA +/- 0.1%
for internal drivers (+ external)
- 50 Ohm Impedance matching for coaxial cable
- Backward measurement of the 4 PU voltages and the 4 currents, accuracy: +/- 0.1% of scale final value

5. Handling card/chassis

Pay attention that the ejection lever of the plug-in card is arrested correctly.
Only the correct position guarantees a justly connection of the bus system and the power supply!



Note

The forcible insertion of the card with displaced HF-sealing spring will damage them. As a result of that HF energy emission will be increased!

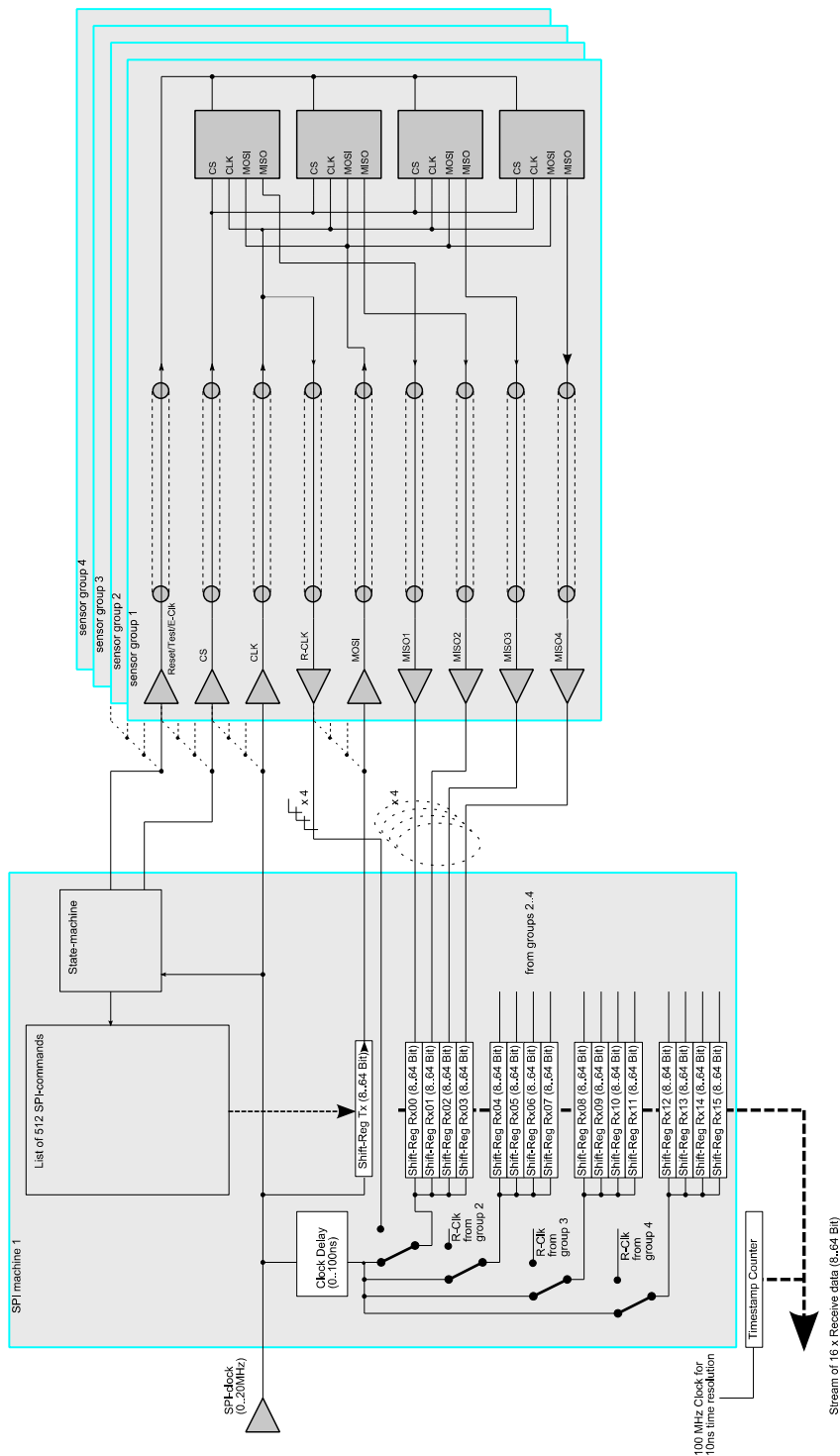
Only with intact HF-sealing spring we guarantee that the whole system conforms to the EMC guidelines.

HF-sealing spring

6. Applications – Working modes

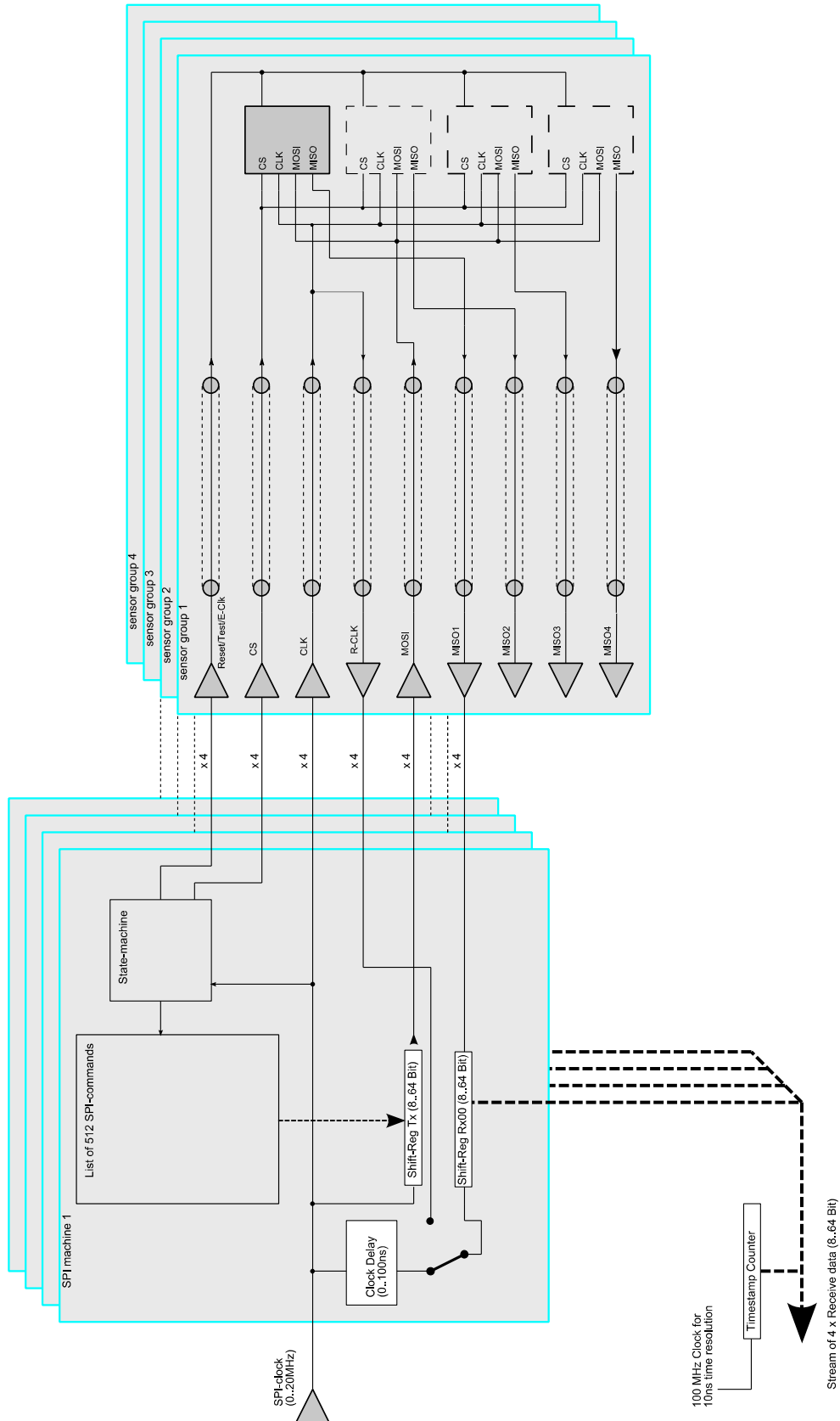
6.1. 16-times highspeed measurement application

To realize an application of 16-times parallel measurement technic a SPI machine is implemented at the FPGA, which controls out of a sending shift register the *Slave-In* of the 16 sensors in common. *Chip-Select*, *Clock* and optionally *Reset/Test* are also controlled in common. The 16 *Slave-Out* lines are executed individually, which are connected with 16 receiving shift register. The commands are send absolutely synchronous, the answer are received individually.



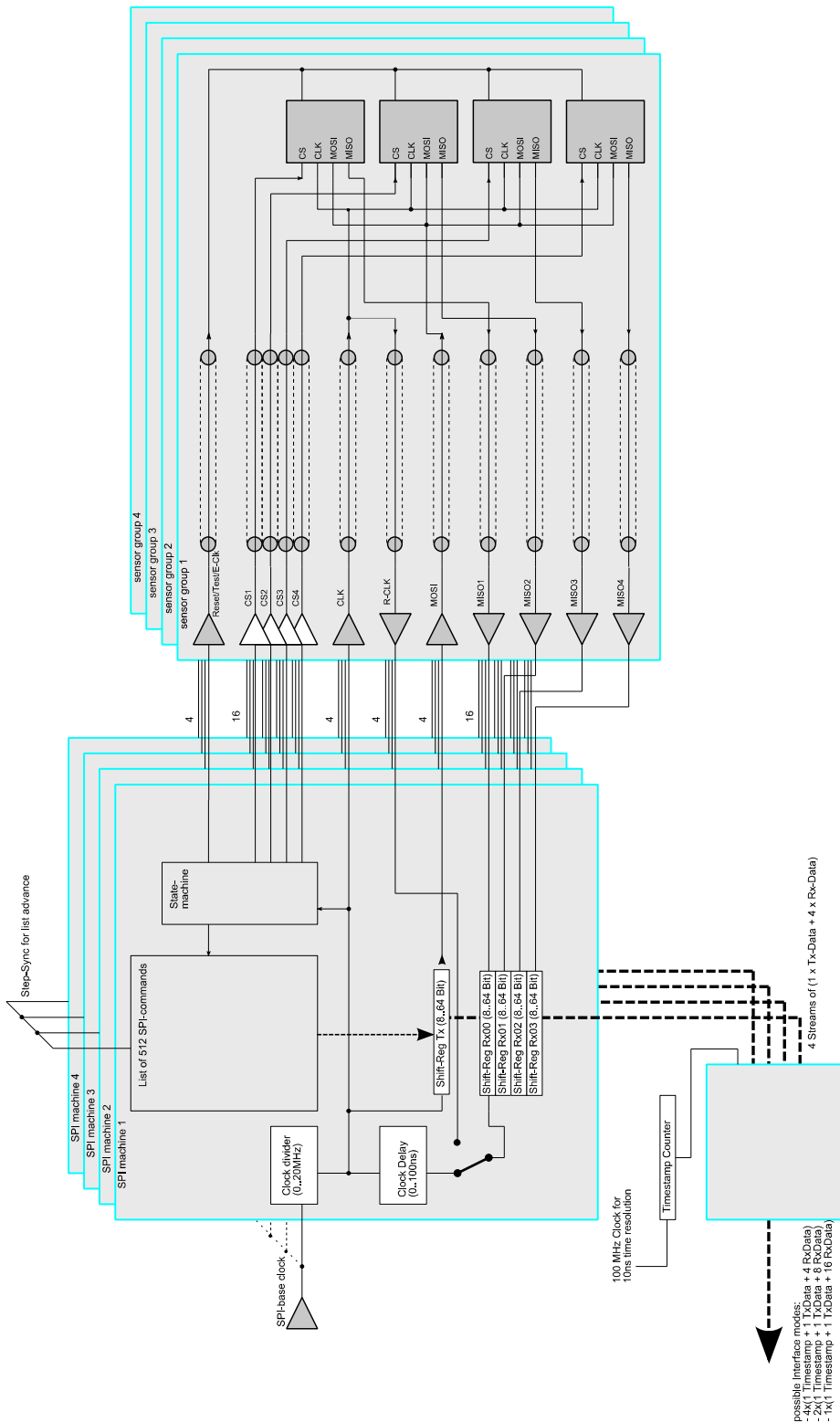
6.2. 4-times comparison application

4 SPI machines each with one own sending- and receiving shift register.
Each SPI machine serves the first sensor of each 4 times group.
The rest of the three sensors of each group stay unpopulated.



6.3. 16-times high-speed measurement application with different sensors

At the FPGA four SPI machines are implemented, which each controls the *Slave-In* of 4 sensors of a group in common out of its 4 sending shift register. *Clock* and optionally *Reset/Test* are also controlled in common. Individually executed are the 16 *Slave-Out* lines, which are connected to the 4 receiving shift register of the 4 groups.



7. Measurement accuracy

7.1. Time base

Test conditions: Environmental temperature 20°C to 26°C						
Num	Evaluation	Symbol	Type	Max	Unit	Comment
1	Accuracy time base	$\Delta f/f$	± 30	± 50	ppm	-
2	Aging of time base	$\Delta f/f_A$	± 5		ppm/year	-
3	Temperature drift of time base	$\Delta f/f_T$	± 0.3	± 0.7	ppm/°C	-

7.2. Measurement of the supply voltage

Test conditions: Environmental temperature 20°C to 26°C						
Num	Evaluation	Symbol	Type	Max	Unit	Comment
4	Accuracy of the measured voltage	U_{mea}	± 0.3	± 0.4	% of scfin. 7.5V	Range 0.5V .. 6.0V
5	Aging of the measured voltage	U_{A-meas}		± 0.1	%/year	Range 0.5V .. 6.0V
6	Resolution of the measured voltages		16		Bit	0.. 65535
			0.1144409		mV/LSB	

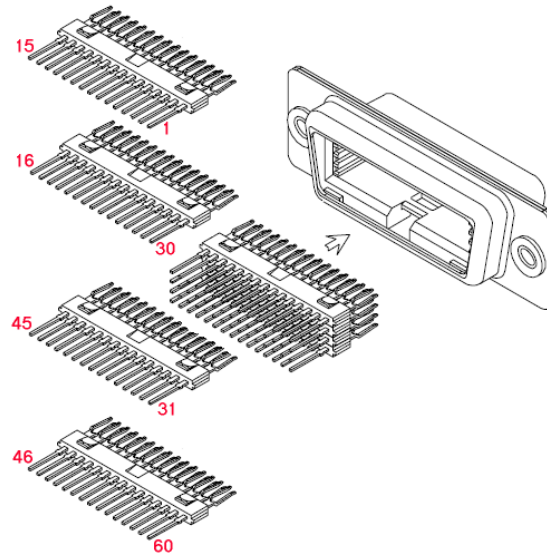
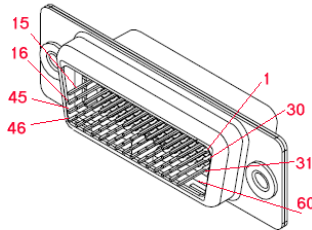
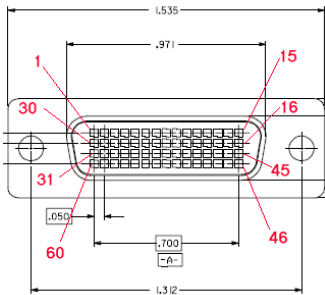
7.3. Measurement of the supply currents

Test conditions: Environmental temperature 20°C to 26°C						
Num	Evaluation	Symbol	Type	Max	Unit	Comment
7	Accuracy of the measured current	I_{mea}	± 0.3	± 0.4	% of scfin. 1000mA	Range 2mA .. 900mA
8	Aging of the measured current	I_{A-meas}		± 0.1	% of scfin. 1000mA / year	Range 2mA .. 900mA
9	Resolution of the measured current		16		Bit	0.. 65535
			15,2587891		µA/LSB	

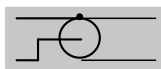
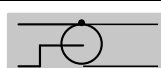
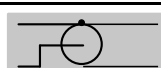
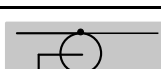
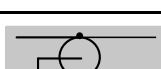
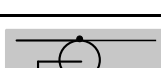
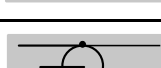
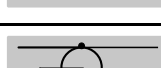
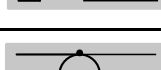
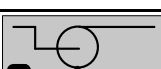

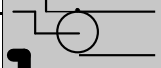

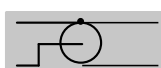
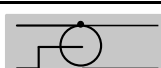

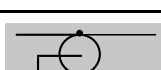
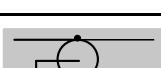
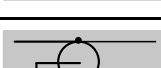
7.4. Generation of the voltages

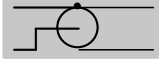
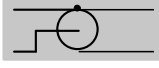
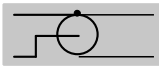
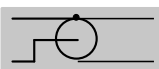
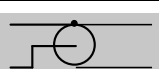

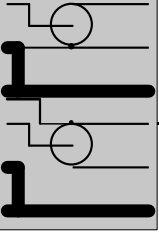

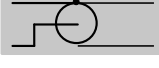
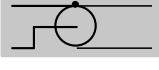
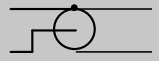
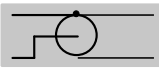
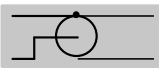

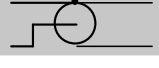
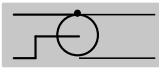
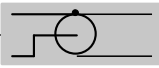
Test conditions: Environmental temperature 20°C to 26°C						
Num	Evaluation	Symbol	Type	Max	Unit	Comment
10	Accuracy of the created current	U_{mea}	± 0.3	± 0.4	% of scfin. 6.3V	Range 0.5V .. 6.0V
11	Aging of the created current	U_{mea}		± 0.1	% of scfin 6.3V / year	Range 0.5V .. 6.0V
12	Resolution of the created current		16		Bit	0.. 65535
			0,096130371		mV/LSB	

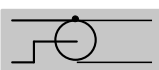
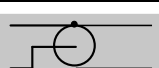
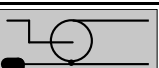

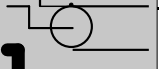

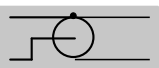
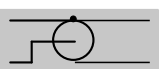
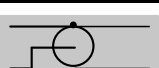
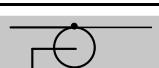
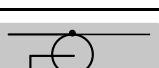
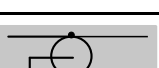
8. Connection diagram X10/X11



Pin	Name X10	Name X11	Cable No.
1	GND IO_01	GND IO_25	K_01
2	SIG IO_01	SIG IO_25	
3	GND IO_02	GND IO_26	K_02
4	SIG IO_02	SIG IO_26	
5	GND IO_03	GND IO_27	K_03
6	SIG IO_03	SIG IO_27	
7	GND IO_04	GND IO_28	K_04
8	SIG IO_04	SIG IO_28	
9	GND IO_05	GND IO_29	K_05
10	SIG IO_05	SIG IO_29	
11	GND IO_06	GND IO_30	K_06
12	SIG IO_06	SIG IO_30	
13	Sens_1_GND	Sens_3_GND	K_07
14	Suppl_1_GND	Suppl_3_GND	
15	Suppl_1_GND	Suppl_3_GND	K_08
16	Sens_1_POS	Sens_3_POS	
17	Suppl_1_POS	Suppl_3_POS	K_09
18	Suppl_1_POS	Suppl_3_POS	
19	GND IO_07	GND IO_31	K_10
20	SIG IO_07	SIG IO_31	
21	GND IO_08	GND IO_32	K_11
22	SIG IO_08	SIG IO_32	
23	GND IO_09	GND IO_33	K_12
24	SIG IO_09	SIG IO_33	

25		GND IO_10		GND IO_34		K_14
26		SIG IO_10		SIG IO_34		
27		GND IO_11		GND IO_35		K_15
28		SIG IO_11		SIG IO_35		
29		GND IO_12		GND IO_36		K_16
30		SIG IO_12		SIG IO_36		
31		GND IO_13		GND IO_37		K_17
32		SIG IO_13		SIG IO_37		
33		GND IO_14		GND IO_38		K_18
34		SIG IO_14		SIG IO_38		
35		GND IO_15		GND IO_39		K_19
36		SIG IO_15		SIG IO_39		
37		GND IO_16		GND IO_40		K_20
38		SIG IO_16		SIG IO_0		
39		GND IO_17		GND IO_41		K_21
40		SIG IO_17		SIG IO_41		
41		GND IO_18		GND IO_42		K_22
42		SIG IO_18		SIG IO_42		
43	V _{DD} Analog	Sens_2_GND	V _{DD} SPI-Interface			K_23
44		Suppl_2_GND		Suppl_4_GND		K_24
45		Suppl_2_GND		Suppl_4_GND		K_25
46		Sens_2_POS				K_26
47		Suppl_2_POS		Suppl_4_POS		
48		Suppl_2_POS		Suppl_4_POS		
49		GND IO_19		GND IO_43		K_27
50		SIG IO_19		SIG IO_43		
51		GND IO_20		GND IO_44		K_28
52		SIG IO_20		SIG IO_44		
53		GND IO_21		GND IO_45		K_29
54		SIG IO_21		SIG IO_45		
55		GND IO_22		GND IO_46		K_30
56		SIG IO_22		SIG IO_46		
57		GND IO_23		GND IO_47		K_31
58		SIG IO_23		SIG IO_47		
59		GND IO_24		GND IO_48		K_32
60		SIG IO_24		SIG IO_48		

Pin	Neutral name X10	4x4 SpiMaMa Name X10	Neutral name X11	4x4 SpiMaMa Name X11	Cable no.
1	GND IO_01		GND IO_25		 K_01
2	SIG IO_01	CLK_G1	SIG IO_25	CLK_G3	
3	GND IO_02		GND IO_26		 K_02
4	SIG IO_02	R_CLK_G1	SIG IO_26	R_CLK_G3	
5	GND IO_03		GND IO_27		 K_03
6	SIG IO_03	MOSI_G1	SIG IO_27	MOSI_G3	
7	GND IO_04		GND IO_28		 K_04
8	SIG IO_04	RES_TEST_E_G1	SIG IO_28	RES_TEST_E_G3	
9	GND IO_05		GND IO_29		 K_05
10	SIG IO_05	CS_G1_S1	SIG IO_29	CS_G3_S1	
11	GND IO_06		GND IO_30		 K_06
12	SIG IO_06	CS_G1_S2	SIG IO_30	CS_G3_S2	
13	Sens_1_GND		Sens_3_GND		 K_07 K_08 K_09 K_10
14	Suppl_1_GND		Suppl_3_GND		
15	Suppl_1_GND		Suppl_3_GND		
16	Sens_1_POS		Sens_3_POS		
17	Suppl_1_POS		Suppl_3_POS		
18	Suppl_1_POS		Suppl_3_POS		
19	GND IO_07		GND IO_31		 K_11
20	SIG IO_07	CS_G1_S3	SIG IO_31	CS_G3_S3	
21	GND IO_08		GND IO_32		 K_12
22	SIG IO_08	CS_G1_S4	SIG IO_32	CS_G3_S4	
23	GND IO_09		GND IO_33		 K_13
24	SIG IO_09	MISO_G1_S1	SIG IO_33	MISO_G3_S1	
25	GND IO_10		GND IO_34		 K_14
26	SIG IO_10	MISO_G1_S2	SIG IO_34	MISO_G3_S2	
27	GND IO_11		GND IO_35		 K_15
28	SIG IO_11	MISO_G1_S3	SIG IO_35	MISO_G3_S3	
29	GND IO_12		GND IO_36		 K_16
30	SIG IO_12	MISO_G1_S4	SIG IO_36	MISO_G3_S4	
31	GND IO_13		GND IO_37		 K_17
32	SIG IO_13	CLK_G2	SIG IO_37	CLK_G4	
33	GND IO_14		GND IO_38		 K_18
34	SIG IO_14	R_CLK_G2	SIG IO_38	R_CLK_G4	
35	GND IO_15		GND IO_39		 K_19
36	SIG IO_15	MOSI_G2	SIG IO_39	MOSI_G4	
37	GND IO_16		GND IO_40		 K_20

38		SIG IO_16	RES_TEST_E_G2		SIG IO_0	RES_TEST_E_G4	
39		GND IO_17			GND IO_41		 K_21
40		SIG IO_17	CS_G2_S1		SIG IO_41	CS_G4_S1	
41		GND IO_18			GND IO_42		 K_22
42		SIG IO_18	CS_G2_S2		SIG IO_42	CS_G4_S2	
43	V _{DD} Analog	Sens_2_GND		V _{DD} SPI-Interface			 K_23
44		Suppl_2_GND			Suppl_4_GND		 K_24
45		Suppl_2_GND			Suppl_4_GND		
46		Sens_2_POS					 K_25
47		Suppl_2_POS			Suppl_4_POS		 K_26
48		Suppl_2_POS			Suppl_4_POS		
49		GND IO_19			GND IO_43		 K_27
50		SIG IO_19	CS_G2_S3		SIG IO_43	CS_G4_S3	
51		GND IO_20			GND IO_44		 K_28
52		SIG IO_20	CS_G2_S4		SIG IO_44	CS_G4_S4	
53		GND IO_21			GND IO_45		 K_29
54		SIG IO_21	MISO_G2_S1		SIG IO_45	MISO_G4_S1	
55		GND IO_22			GND IO_46		 K_30
56		SIG IO_22	MISO_G2_S2		SIG IO_46	MISO_G4_S2	
57		GND IO_23			GND IO_47		 K_31
58		SIG IO_23	MISO_G2_S3		SIG IO_47	MISO_G4_S3	
59		GND IO_24			GND IO_48		 K_32
60		SIG IO_24	MISO_G2_S4		SIG IO_48	MISO_G4_S4	

10. Connection cable

K_01 .. K_07, K_09, K_11 .. K_23, K_25, K_27 .. K_32	Coaxial cable, 1,3mm diameter
K_08, K_10, K_24, K_26	Litz wire 0,75mm ² 2mm diameter
All cable length =2m, end open	

